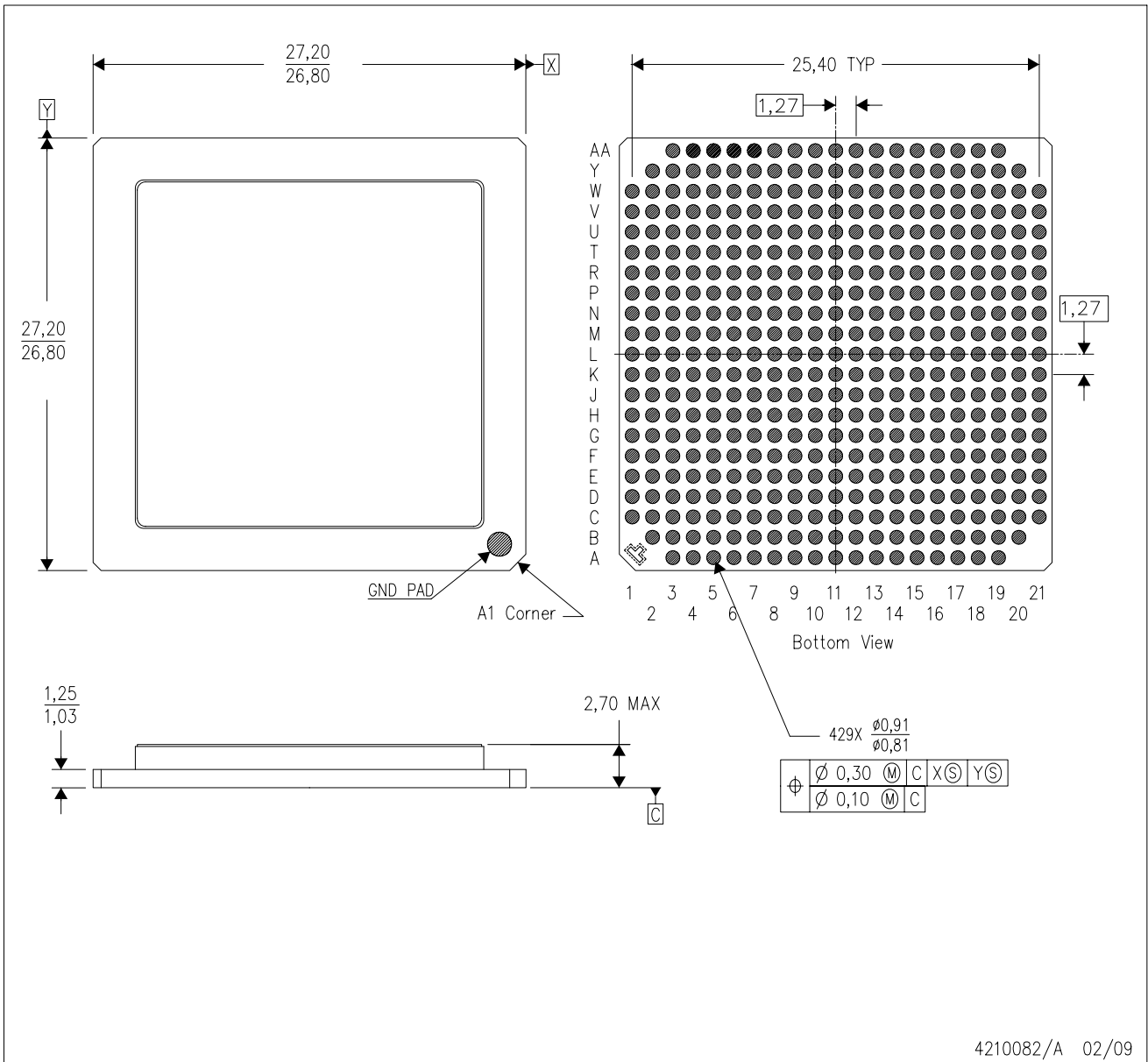


ZMB (S-CLGA-N429)

CERAMIC LAND GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Flip chip application only.
 - D. All Ball Pads are Gold plated.

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